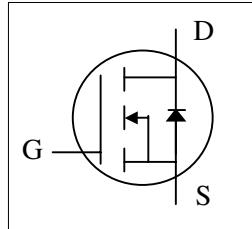
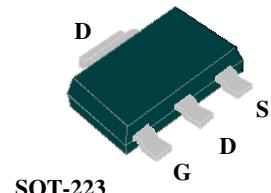




- ▼ Lower Gate Charge
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



BV_{DSS}	200V
$R_{DS(ON)}$	1.2Ω
I_D	1A



Description

AP04N20 uses rugged design with the best combination of fast switching and cost-effectiveness.

The SOT-223 package is designed for surface mount application, larger heatsink than SO-8 and SOT package.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	200	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^3$	1	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^3$	0.8	A
I_{DM}	Pulsed Drain Current ¹	4	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	2.7	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	45	°C/W



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	200	-	-	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=1\text{A}$	-	-	1.2	Ω
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=0.6\text{A}$	-	-	1.3	Ω
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	-	3	V
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=1\text{A}$	-	2.8	-	S
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=160\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	25	μA
I_{GSS}	Gate-Source Leakage	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_{g}	Total Gate Charge ²	$\text{I}_D=1\text{A}$ $\text{V}_{\text{DS}}=160\text{V}$	-	8.5	14	nC
Q_{gs}	Gate-Source Charge		-	1.1	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	2.1	-	nC
$t_{\text{d(on)}}$	Turn-on Delay Time ²	$\text{V}_{\text{DD}}=100\text{V}$	-	4	-	ns
t_r	Rise Time	$\text{I}_D=1\text{A}$ $\text{R}_G=3.3\Omega$	-	6	-	ns
$t_{\text{d(off)}}$	Turn-off Delay Time		-	16	-	ns
t_f	Fall Time	$\text{V}_{\text{GS}}=10\text{V}$	-	6.5	-	ns
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}$ $\text{V}_{\text{DS}}=25\text{V}$	-	225	360	pF
C_{oss}	Output Capacitance		-	50	-	pF
C_{rss}	Reverse Transfer Capacitance		-	15	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$\text{I}_S=1\text{A}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1.3	V
t_{rr}	Reverse Recovery Time ²	$\text{I}_S=1\text{A}, \text{V}_{\text{GS}}=0\text{V},$ $d\text{I}/dt=100\text{A}/\mu\text{s}$	-	90	-	ns
Q_{rr}	Reverse Recovery Charge	-	260	-	nC	

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board, $t \leq 10\text{sec}$; $120^\circ\text{C}/\text{W}$ when mounted on Min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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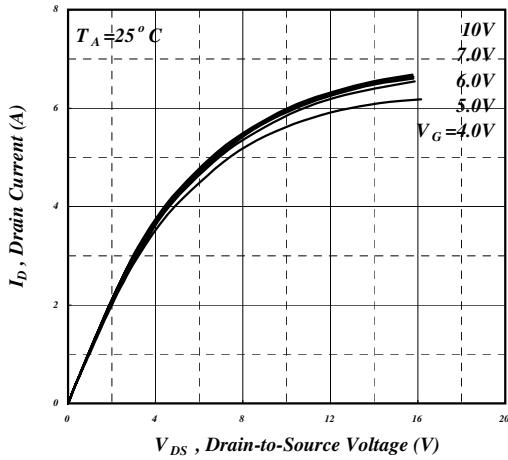


Fig 1. Typical Output Characteristics

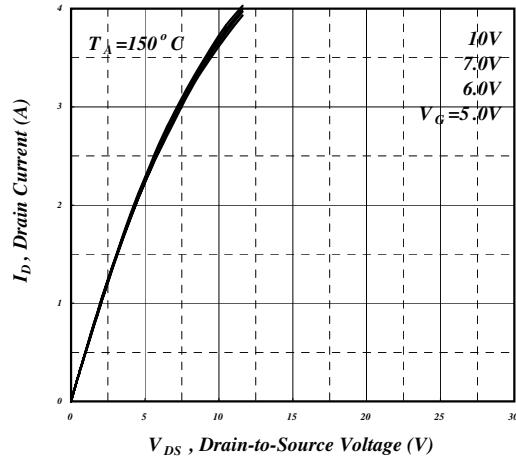


Fig 2. Typical Output Characteristics

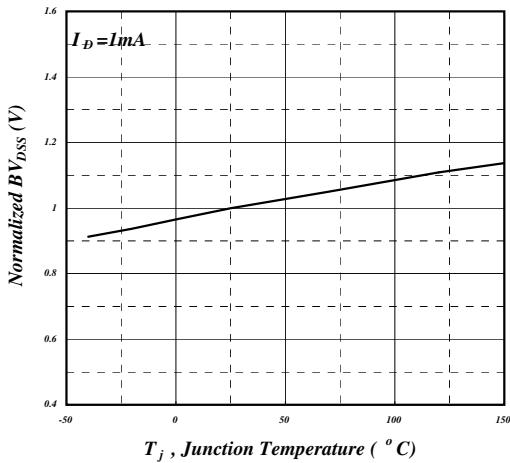
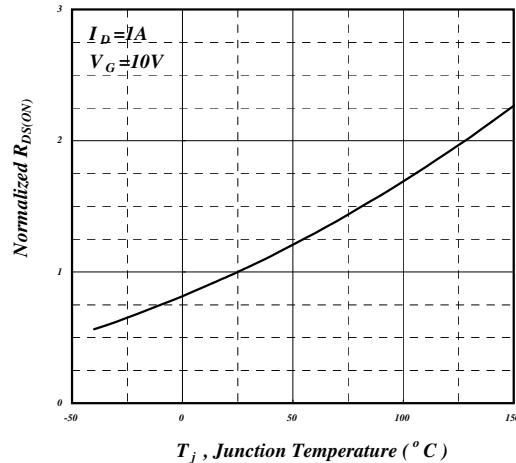
Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature

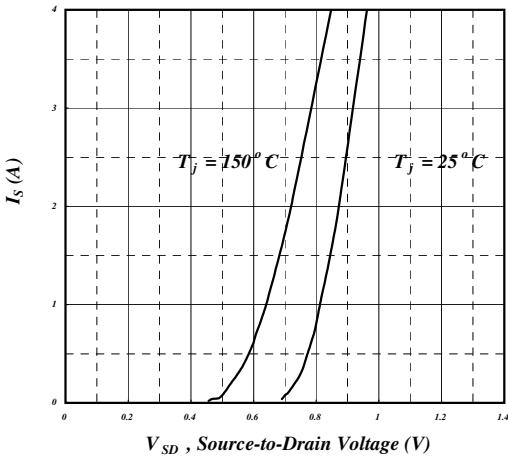


Fig 5. Forward Characteristic of Reverse Diode

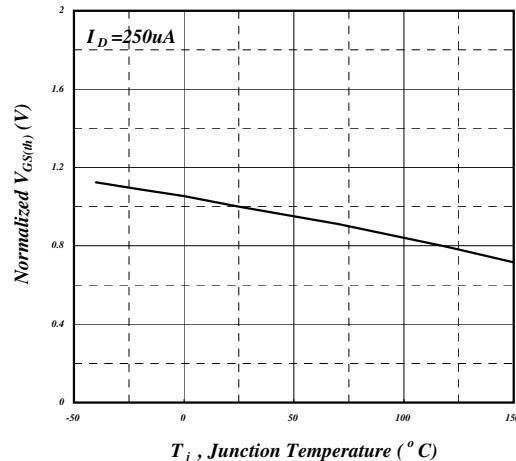


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

AP04N20GK-HF

